



## **SPECIFICATION**

- · Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- · Samsung P/N : · Description :
- CL21A106KPFNNWE

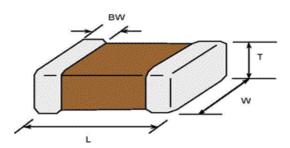
(Reference sheet)

CAP, 10uF, 10V, ±10%, X5R, 0805

A. Samsung Part Number

		<u>C</u>		<mark>4</mark> 3	<u>106</u> ④	<u>K</u> 5	<u>P</u> 6	<u>Е</u> ⑦	<u>N</u> 8	<u>N</u> 9	<u>W</u> 10	<u>Е</u> Ш		
1	Series	Samsung Multi-layer Ceramic Capacitor												
2	Size	0805 (incl	n code)		L:	2.00	± 0.10	mm			W:	1.25 ± 0.10	mm	
3	Dielectric	X5R				8	Inner	elect	rode			Ni		
4	Capacitance	10 uF					Term	inatic	n			Cu		
5	Capacitance	±10 %					Platir	ng				Sn 100%	(Pb Free)	
	tolerance					9	Prod	uct				Normal		
6	Rated Voltage	10 V				10	Spec	ial				Industrial (N	etwork,etc)	
1	Thickness	1.25 ± 0.10 m	m			1	Pack	aging				Embossed 7	Гуре, 7" reel	

## **B. Structure & Dimension**



Samsung P/N	Dimension(mm)								
Samsung F/N	L	W	Т	BW					
CL21A106KPFNNWE	2.00 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	0.50 +0.20/-0.30					

## C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition						
Capacitance	Within specified tolerance	1 <sup>kHz</sup> ±10% / 1.0±0.2Vrms						
Tan δ (DF)	0.1 max.	*A capacitor prior to measuring the capacitance is heat treated at 150°C+0/-10°C for 1 hour and maintained in ambient air for 24±2 hours.						
Insulation	10,000Mohm or 100Mohm×µF	Rated Voltage 60~120 sec.						
Resistance	Whichever is smaller							
Appearance	No abnormal exterior appearance	Microscope (×10)						
Withstanding	No dielectric breakdown or	250% of the rated voltage						
Voltage	mechanical breakdown							
Temperature	X5R							
Characteristics	(From-55℃ to 85℃, Capacitance change s	nould be within ±15%)						
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.						
of Termination	terminal electrode							
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)						
		with 1.0mm/sec.						
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder						
	is to be soldered newly	245±5℃, 3±0.3sec.						
		(preheating : 80~120℃ for 10~30sec.)						
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.						
Soldering Heat	Tan δ, IR : initial spec.							
Vibration Test	Capacitance change : within $\pm 5\%$ Tan $\delta$ , IR : initial spec.	Amplitude : 1.5mm From 10Hz to 55Hz (return : 1min.) 2hours × 3 direction (x, y, z)						
Moisture	Capacitance change : within ±12.5%	With rated voltage						
Resistance	Tan δ : 0.125 max	40±2℃, 90~95%RH, 500+12/-0hrs						
	IR : 500Mohm or 12.5Mohm × <sup>µ</sup> F Whichever is smaller							
High Temperature	Capacitance change : within ±12.5%	With <sup>150%</sup> of the rated voltage						
Resistance	Tan δ : 0.125 max	Max. operating temperature						
	IR : 1,000Mohm or 25Mohm × <i>μ</i> F Whichever is smaller	1,000+48/-0hrs						
Temperature	Capacitance change : within ±7.5%	1 cycle condition						
Cycling	Tan δ, IR : initial spec.	Min. operating temperature $\rightarrow$ 25°C						
		→ Max. operating temperature → $25^{\circ}$ C						
		5 cycle test						

 $\,\%$  The reliability test condition can be replaced by the corresponding accelerated test condition.

## D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260±5°C, 30sec. )

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.